

Features

- ESD protection for one line with uni-directional
- Provide transient protection for each line to IEC 61000-4-2 (ESD) ±18kV (air / contact)
 IEC 61000-4-4 (EFT) ±50A (5/50ns)
 IEC 61000-4-5 (Lightning) 5A (8/20µs)
- Suitable for, 24V and below, operating voltage applications
- 0201 small MCSP package saves board space
- Protect one I/O line or one power line
- Fast turn-on and low clamping voltage
- Solid-state silicon-avalanche and active circuit triggering technology
- Green part

Applications

- Power supply protection
- USB power delivery
- Small panel modules
- Handheld portable applications
- Low speed data or control line protection
- Peripherals
- Consumer electronics

Description

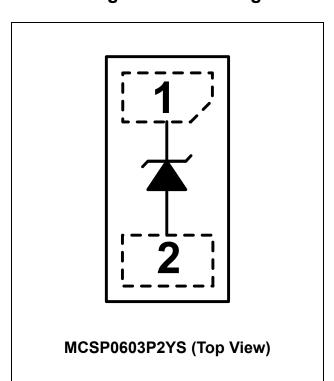
AZ4U24-01M is a design which includes a uni-directional surge rated clamping cell to protect one power line, or one control line, or one low speed data line in an electronic system. The AZ4U24-01M has been specifically designed to protect sensitive components which are connected to power and control lines from

over-voltage damage caused by Electrostatic Discharging (ESD), Electrical Fast Transients (EFT), Lightning, and Cable Discharge Event (CDE).

AZ4U24-01M is a unique design which includes proprietary clamping cell in a single package. During transient conditions, the proprietary clamping cell prevents over-voltage on the power line or control/data lines, protecting any downstream components.

AZ4U24-01M may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge).

Circuit Diagram / Pin Configuration





Specifications

Absolute Maximum Ratings (T _A = 25°C, unless otherwise specified)				
Parameter	Symbol	Rating	Unit	
Peak Pulse Current (t _p =8/20μs) (Note 1)	I _{PP}	5	А	
Operating Voltage	V _{DC}	26.4	V	
ESD per IEC 61000-4-2 (Air)	V _{ESD-1}	±18	kV	
ESD per IEC 61000-4-2 (Contact)	V _{ESD-2}	±18	KV	
Lead Soldering Temperature	T _{SOL}	260 (10 sec.)	°C	
Operating Temperature	T _{OP}	-55 to +125	°C	
Storage Temperature	T _{STO}	-55 to +150	°C	

Electrical Characteristics						
Parameter	Symbol Condition		Min	Тур	Max	Unit
Reverse Stand-Off Voltage	V_{RWM}	Pin-1 to pin-2, T=25 °C.			24	V
Reverse Leakage Current	I _{Leak}	V_{RWM} = 24V, T=25 °C, pin-1 to pin-2.			0.1	μΑ
Reverse Breakdown Voltage	V_{BV}	I_{BV} = 1mA, T=25 °C, pin-1 to pin-2.	26.8		31.3	V
Forward Voltage	V _F	I_F = 15mA, T=25 °C, pin-2 to pin-1.	1		2	V
Surge Clamping Voltage (Note 1)	$V_{\text{CL-surge}}$	$I_{PP} = 5A$, $t_p = 8/20 \mu s$, $T=25^{\circ}C$.		35		٧
ESD Clamping Voltage (Note 2)	V _{CL-ESD}	IEC 61000-4-2 +8kV (I _{TLP} = 16A), contact mode, T=25 °C, pin-1 to pin-2.		36		V
ESD Dynamic Turn-on Resistance	R _{dynamic}	IEC 61000-4-2 0~+8kV, T=25 °C, contact mode, pin-1 to pin-2.		0.45		Ω
Channel Input Capacitance	C _{IN}	C_{IN} $V_R = 0V$, $f = 1MHz$, pin-1 to pin-2, $T=25$ °C.		11	15	pF

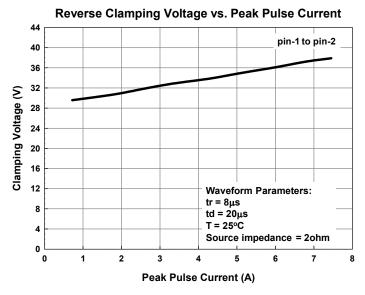
Note 1: The Peak Pulse Current measured conditions: t_p = 8/20 μ s, 2Ω source impedance.

Note 2: ESD Clamping Voltage was measured by Transmission Line Pulsing (TLP) System.

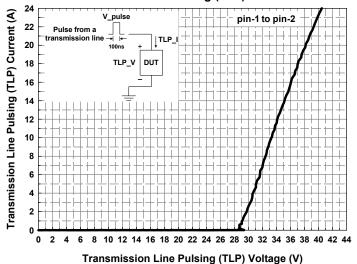
TLP conditions: Z_0 = 50 Ω , t_p = 100ns, t_r = 1ns.



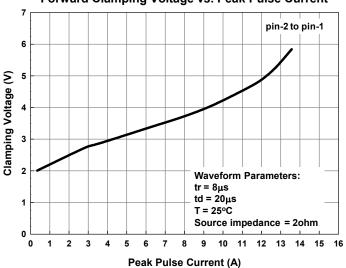
Typical Characteristics



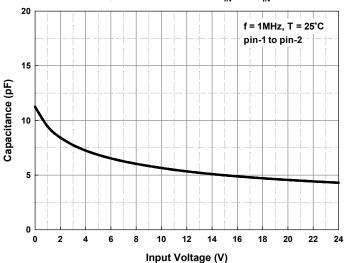




Forward Clamping Voltage vs. Peak Pulse Current



Typical Variation of C_{IN} vs. V_{IN}





Applications Information

The AZ4U24-01M is designed to protect one line against system ESD / EFT / Lightning pulses by clamping it to an acceptable reference.

The usage of the AZ4U24-01M is shown in Fig. 1. Protected lines, such as data lines, control lines, or power lines, are connected to pin 1. The pin 2 should be connected directly to a ground plane on the board. All path lengths connected to the pins of AZ4U24-01M should be kept as short as possible to minimize parasitic inductance in the board traces.

In order to obtain enough suppression of ESD induced transient, a good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ4U24-01M.
- Place the AZ4U24-01M near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to.

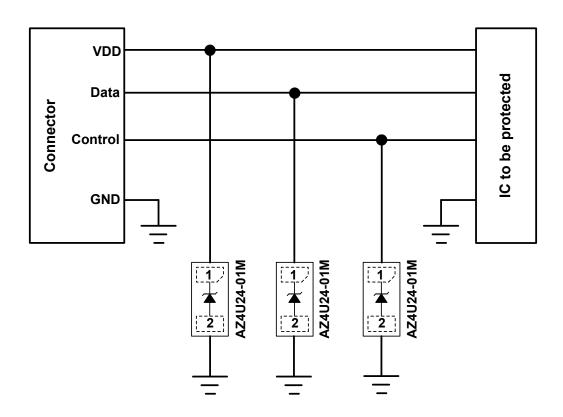
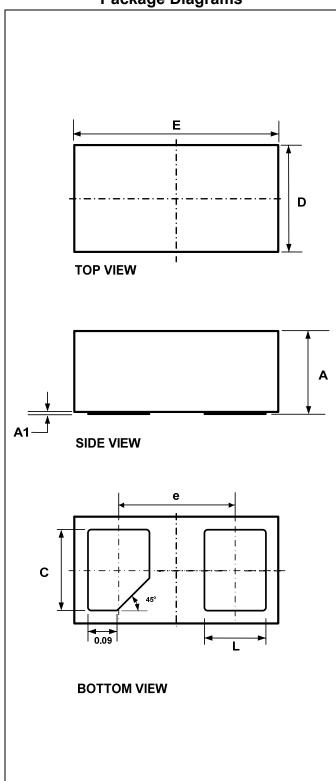


Fig. 1



Mechanical Details MCSP0603P2YS

Package Diagrams

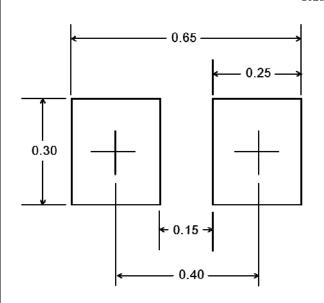


Package Dimensions

SYMBOL	MILLIMETERS			
STIVIBUL	MIN.	NOM.	MAX.	
E	0.615	0.630	0.645	
D	0.315	0.330	0.345	
Α	0.235	0.250	0.265	
A 1	0.005	0.015	0.050	
L	0.170	0.190	0.210	
С	0.230	0.250	0.270	
е		0.360 BSC		

Land Layout

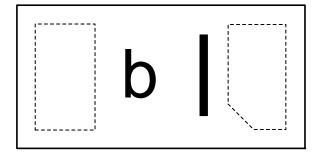
Unit: mm



Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

Marking Code



b= Device Code

Part Number	Marking Code
AZ4U24-01M.R7G (Green Part)	b

Note: Green means Pb-free, RoHS, and Halogen free compliant.

Ordering Information

PN#	Material	Type	Reel size	MOQ	MOQ/internal box	MOQ/carton
AZ4U24-01M.R7G	Green	T/R	7 inch	15,000/reel	4 reels = 60,000/box	6 boxes = 360,000/carton

Revision History

Revision	Modification Description
Revision 2023/07/25	Formal Release.